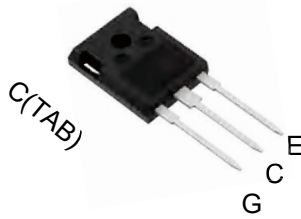
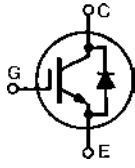
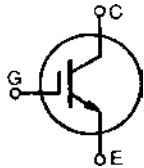


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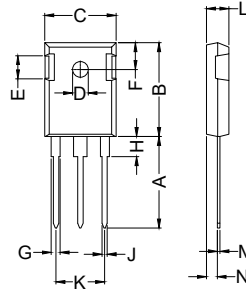
Discrete IGBTs



G=Gate,
C=Collector,
E=Emitter,
TAB=Collector



Dimensions TO-247AD



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	19.81	20.32	0.780	0.800
B	20.80	21.46	0.819	0.845
C	15.75	16.26	0.620	0.640
ØD	3.15	3.65	0.124	0.144
E	4.32	5.49	0.170	0.216
F	5.40	6.30	0.213	0.248
G	1.65	2.18	0.065	0.086
H	3.80	4.50	0.150	0.177
J	1.00	1.40	0.039	0.055
K	10.80	11.10	0.425	0.437
L	4.70	5.30	0.185	0.209
M	0.40	0.80	0.016	0.031
N	1.50	2.49	0.059	0.098

IGBT SG40T65UB2 SG40T65UDB2

Symbol	Test Conditions	Maximum Ratings	Unit
V _{CES} V _{CGR}	T _J =25°C to 150°C T _J =25°C to 150°C; R _{GE} =1 MΩ;	650 650	V
V _{GES} V _{GEM}	Continuous Transient	±20 ±30	V
I _{C25} I _{C100} I _{CM}	T _C =25°C T _C =100°C T _C =25°C, 1 ms	80 40 120	A
SSOA (RBSOA)	V _{GE} =15V; T _{VJ} =125°C; R _G =22Ω Clamped inductive load; L=100uH	I _{CM} =80 @ 0.8 V _{CES}	A
P _c	T _C =25°C	250	W
T _J T _{JM} T _{stg}		-55...+150 150 -55...+150	°C
	Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10s	300	°C
M _d	Mounting torque	1.13/10	Nm/lb.in.
Weight	Typical	6	g

(T_J=25°C, unless otherwise specified)

Symbol	Test Conditions	Characteristic Values			Unit
		min.	typ.	max.	
BV _{CES}	I _C =250uA; V _{GE} =0V	650			V
V _{GE(th)}	I _C =250uA; V _{CE} =V _{GE}	4.5	5.5	7.0	V
I _{CES}	V _{CE} =0.8V _{CES} ; T _J =25°C V _{GE} =0V; T _J =150°C			250 1	uA mA
I _{GES}	V _{CE} =0V; V _{GE} =±20V			±100	nA
V _{CE(sat)}	I _C =40A; V _{GE} =15V		1.65	2.10	V

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SG40T65UB2 SG40T65UDB2

Discrete IGBTs

(T_J=25°C, unless otherwise specified)

Symbol	Test Conditions	Characteristic Values			Unit
		min.	typ.	max.	
g _{ts}	I _C =40A; V _{CE} =10V Pulse test, t ≤ 300us, duty cycle ≤ 2%	20	30		S
C _{ies} C _{oes} C _{res}	V _{CE} =25V; V _{GE} =0V; f=1MHz		3100 220 120	4000	pF
Q _g Q _{ge} Q _{gc}	I _C =40A; V _{GE} =15V; V _{CE} =0.5V _{CES}		150 25 80		nC
t _{d(on)} t _{ri} t _{d(off)} t _{fi} E _{off}	Inductive load, T _J =25°C I _C =40A; V _{GE} =15V; L=100uH V _{CE} =0.5V _{CES} ; R _G =R _{off} =10Ω Remarks: Switching times may increase for V _{CE} (Clamp) > 0.8V _{CES} ; higher T _J or increased R _G		50 35 200 35 0.65		ns ns ns ns mJ
t _{d(on)} t _{ri} E _{on} t _{d(off)} t _{fi} E _{off}	Inductive load, T _J =125°C I _C =40A; V _{GE} =15V; L=100uH V _{CE} =0.5V _{CES} ; R _G =R _{off} =10Ω Remarks: Switching times may increase for V _{CE} (Clamp) > 0.8V _{CES} ; higher T _J or increased R _G		50 40 0.90 220 50 0.90		ns ns mJ ns ns mJ
R _{thJC}				0.73	K/W
R _{thCK}			0.25		K/W

Reverse Diode (FRED)

(T_J=25°C, unless otherwise specified)

Symbol	Test Conditions	Characteristic Values			Unit
		min.	typ.	max.	
V _F	I _F =40A; V _{GE} =0V; T _J =125°C Pulse test, t ≤ 300us, duty cycle ≤ 2%; T _J =25°C		1.75 1.70	2.5	V
I _{RM} t _{rr}	I _F =40A; V _{GE} =0V; -di _F /dt=100A/us V _R =100V; T _J =125°C I _F =40A; -di/dt=100A/us; V _R =30V; T _J =25°C		20 150 90		A ns ns
R _{thJC}				1.0	K/W



SG40T65UB2 SG40T65UDB2

Discrete IGBTs

Features

- Trench Field Stop IGBT technology
- Low switching losses
- Switching frequency up to 50 kHz
- Square RBSOA, no latch up
- High short circuit capability
- Positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- Ultra fast free wheeling diodes

Application

- AC and DC motor control
- AC servo and robot drives
- power supplies
- welding inverters

Advantages

- space and weight savings
- reduced protection circuits

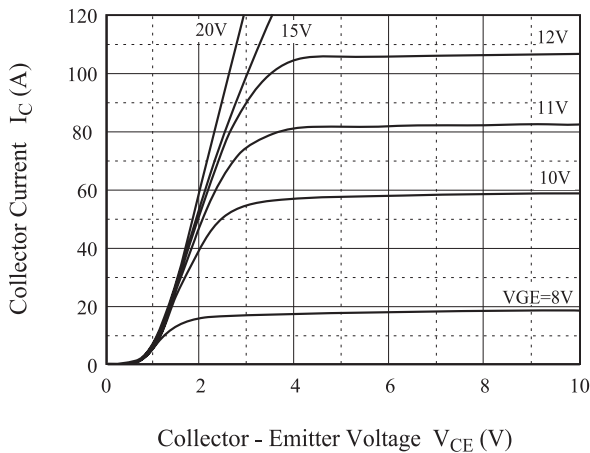


Fig 1. Saturation Voltage Characteristics

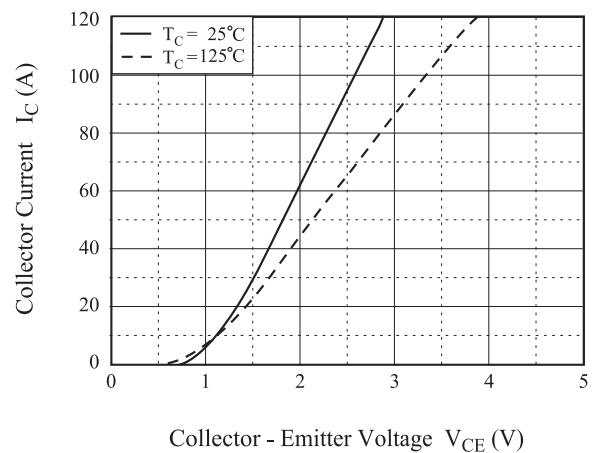


Fig 2. Saturation Voltage Characteristics

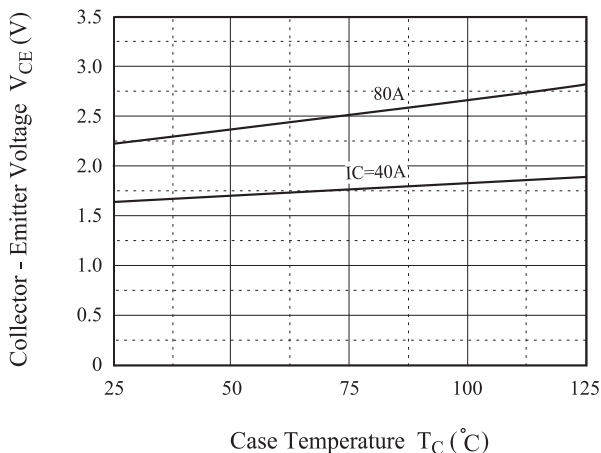


Fig 3. Saturation Voltage vs. Case Temperature

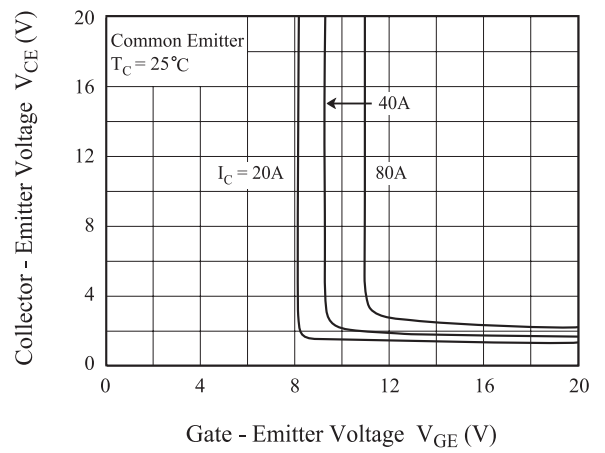
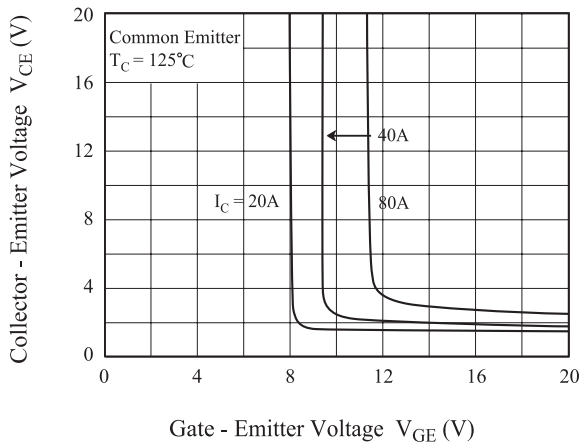


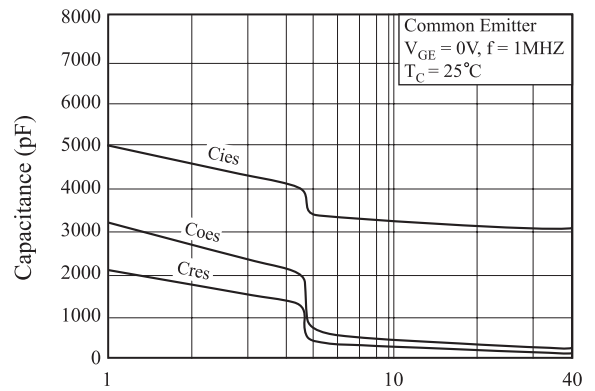
Fig 4. Saturation Voltage vs. V_{GE}

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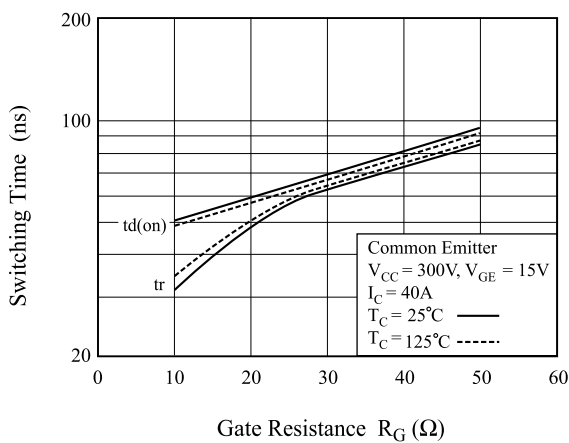
Discrete IGBTs



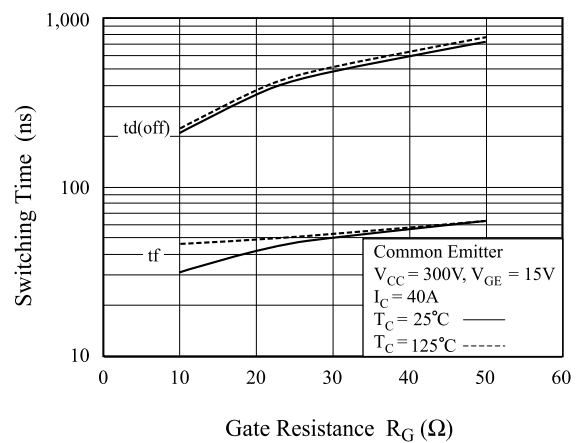
Gate - Emitter Voltage V_{GE} (V)
Fig 5. Saturation Voltage vs. V_{GE}



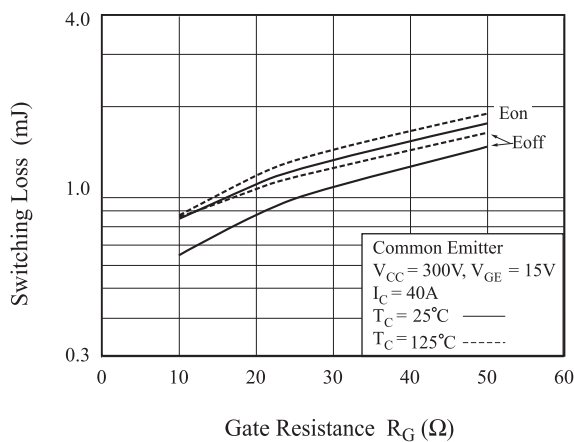
Collector - Emitter Voltage V_{CE} (V)
Fig 6. Capacitance Characteristics



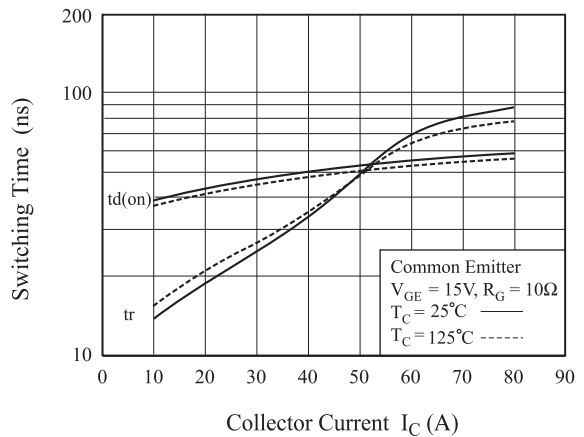
Gate Resistance R_G (Ω)
Fig 7. Turn-On Characteristics vs. Gate Resistance



Gate Resistance R_G (Ω)
Fig 8. Turn-Off Characteristics vs. Gate Resistance



Gate Resistance R_G (Ω)
Fig 9. Switching Loss vs. Gate Resistance



Collector Current I_C (A)
Fig 10. Turn-On Characteristics vs. Collector Current



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Discrete IGBTs

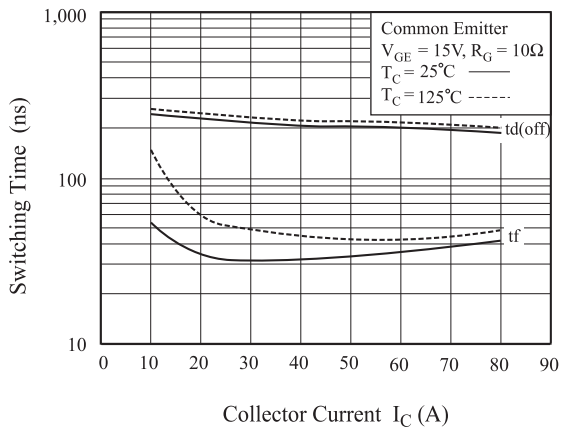


Fig 11. Turn-Off Characteristics vs. Collector Current

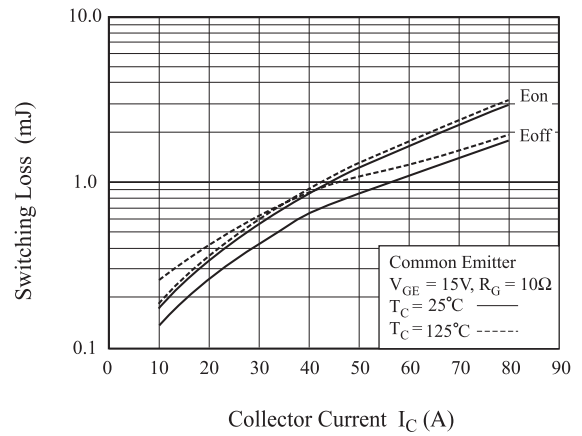


Fig 12. Switching Loss vs. Collector Current

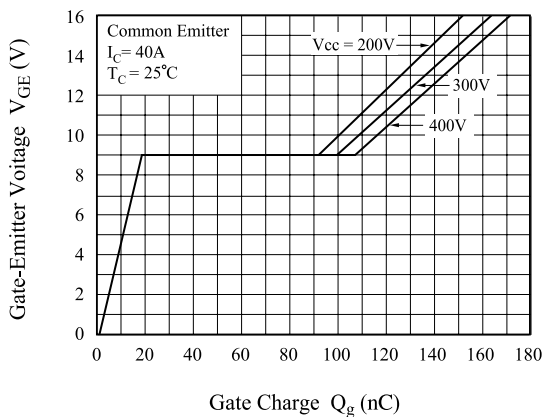


Fig 13. Gate Charge Characteristics

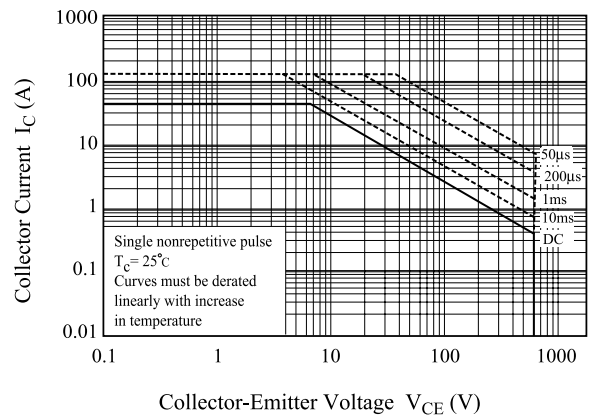


Fig 14. SOA Characteristics

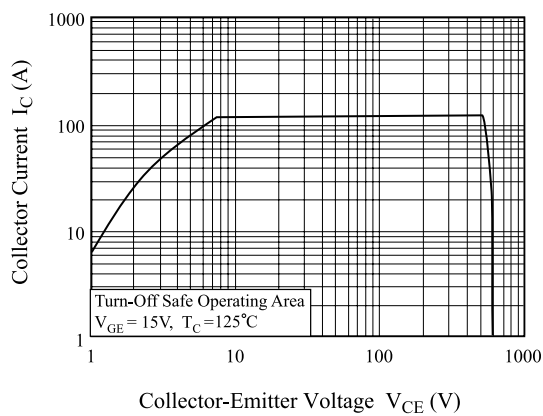


Fig 15. Turn-Off SOA



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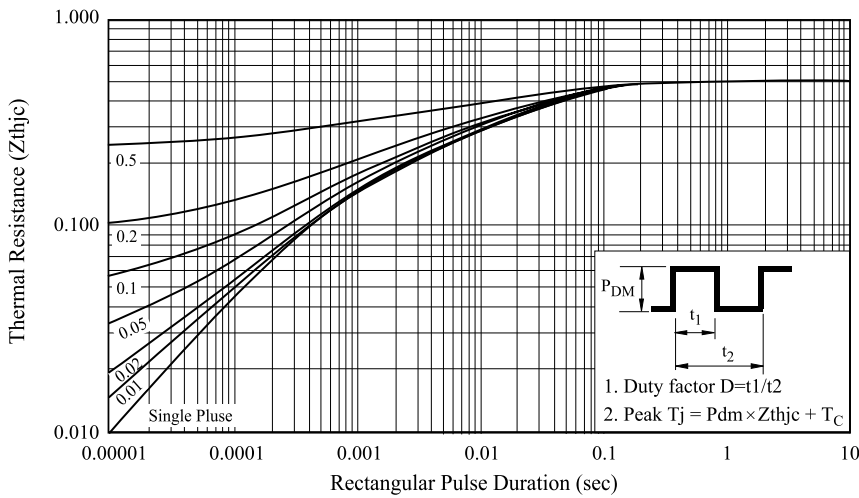


Fig 16. Transient Thermal Impedance of IGBT

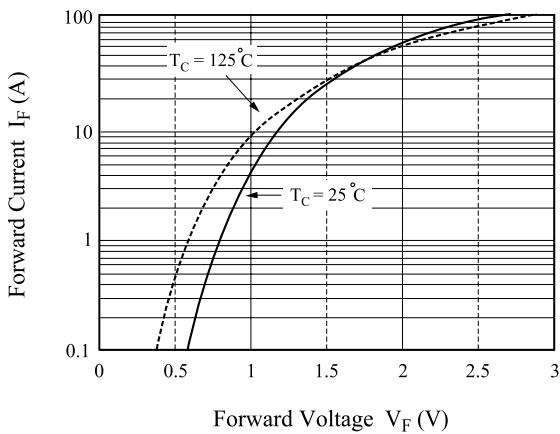


Fig 17. Forward Characteristics

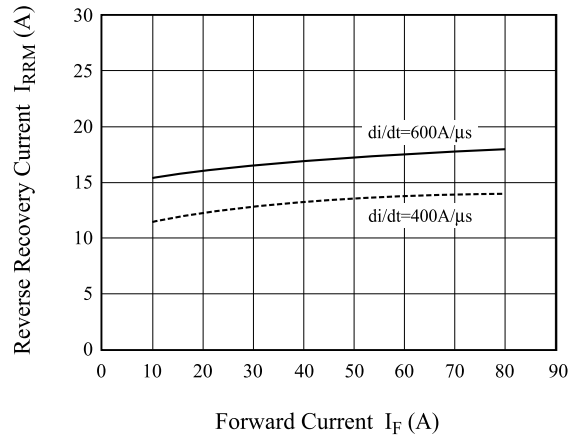


Fig 18. Reverse Recovery Current

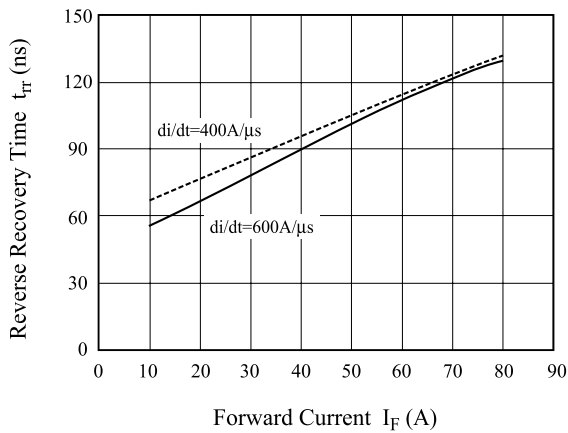


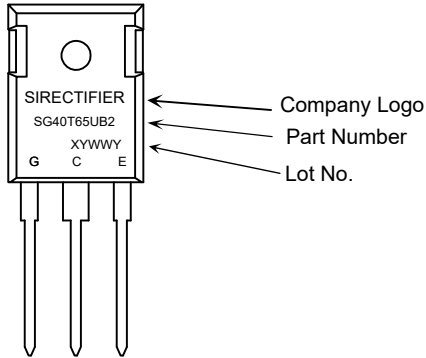
Fig 19. Reverse Recovery Time

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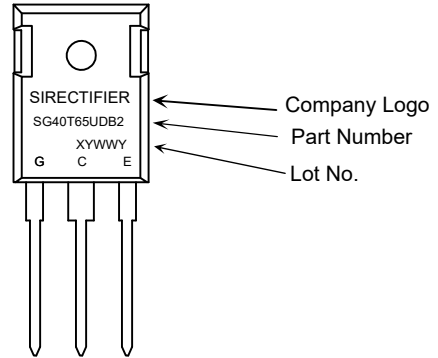
Discrete IGBTs

Marking

SG40T65UB2
(TO-247AD)



SG40T65UDB2
(TO-247AD)



Ordering Information

Part Number	Package	Shipping	Marking Code
SG40T65UB2	TO-247AD	30pcs / Tube	SG40T65UB2
SG40T65UDB2	TO-247AD	30pcs / Tube	SG40T65UDB2